

Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 26 D-32758 Detmold Germany

www.weidmueller.com

### **Product image**



Similar to illustration

# The new benchmark for component density: the virtual 0.875mm pitch - for 1mm<sup>2</sup> I/O connections

The only 4-row double level male connectors for standard IP20 sensor interfaces with 3.5 pitch

The S2L in a double pack - a standard has surpassed itself:

- Each 3.5mm wide, 4 I/O contacts for 1mm² connection cross-section
- Force-fit enclosure geometry guarantees maximum stability
- Solder flange eliminates the need for a screw fastening

Less is more - basic advantages for your applications:

- 75% space savings on the circuit board
- Solder flange reduces process costs
- Less mechanical load on the soldering points
- More space for displays in the front panel, for example

A "small" contribution to greater competitiveness: additional features in the same installation space or a more compact device with the same range of functions.

















### **General ordering data**

Version	PCB plug-in connector, male header, closed side / solder flange, THT/THR solder connection, 3.50 mm, Number of poles: 32, 90°, Solder pin length (I): 3.2 mm, tinned, black, Box
Order No.	<u>1357970000</u>
Туре	S2CD-THR 3.50/32/90LF 3.2SN BK BX
GTIN (EAN)	4050118160925
Qty.	20 pc(s).
Product data	IEC: 200 V / 7.9 A UL: 150 V / 9.5 A
Packaging	Вох



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## **Technical data**

### **Dimensions and weights**

Depth	24.4 mm	Depth (inches)	0.961 inch
Height	35 mm	Height (inches)	1.378 inch
Height of lowest version	31.8 mm	Net weight	19 g
Width	35 mm	Width (inches)	1.378 inch

### **System specifications**

Product family	OMNIMATE Signal - series B2C/S2C 3.50 - 2-row	Type of connection	Board connection
Mounting onto the PCB	THT/THR solder	Pitch in mm (P)	3.5 mm
Pitch in inches (P)	0.138 inch	Outgoing elbow	90°
Number of poles	32	Number of solder pins per pole	1
Solder pin length (I)	3.2 mm	Solder pin dimensions	d = 1.0 mm, Octagonal
Solder eyelet hole diameter (D)	1.3 mm	Solder eyelet hole diameter tolerand	ce (D)+ 0,1 mm
Outside diameter of solder pad	2.1 mm	Template aperture diameter	1.9 mm
L1 in mm	52.5 mm	L1 in inches	2.067 inch
Pin series quantity		Touch-safe protection acc. to DIN VI	DE
•	2	57 106 ·	Safe from finger touch
Touch-safe protection acc. to DIN VI	DE	Can be coded	
0470	IP 20		Yes

### **Material data**

Insulating material	LCP GF	Colour	black
Colour chart (similar)	RAL 9011	Insulating material group	IIIb
Comparative Tracking Index (CTI)	≥ 175	Moisture Level (MSL)	1
UL 94 flammability rating	V-0	Contact material	Copper alloy
Contact surface		Layer structure of solder connection	13 µm Ni / 25 µm Sn
	tinned		matt
Layer structure of plug contact	25 μm Sn / 13 μm Ni	Storage temperature, min.	-40 °C
Storage temperature, max.	70 °C	Operating temperature, min.	-50 °C
Operating temperature, max.	120 °C	Temperature range, installation, min.	-40 °C
Temperature range, installation, max.	120 °C		

### Rated data acc. to IEC

tested acc. to standard	IEC 60664-1, IEC 61984	Rated current, min. number of poles (Tu=20°C)	7.9 A
Rated current, max. number of poles (Tu=20°C)	5 A	Rated current, min. number of poles (Tu=40°C)	6.8 A
Rated current, max. number of poles (Tu=40°C)	5 A	Rated voltage for surge voltage class / pollution degree II/2	200 V
Rated voltage for surge voltage class / pollution degree III/2	160 V	Rated voltage for surge voltage class / pollution degree III/3	100 V
Rated impulse voltage for surge voltage class/ pollution degree II/2	2.5 kV	Rated impulse voltage for surge voltage class/ pollution degree III/2	2.5 kV
Rated impulse voltage for surge voltage class/ contamination degree III/3	1.5 kV	Short-time withstand current resistance	3 x 1s with 80 A



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## **Technical data**

### Rated data acc. to CSA

Institute (CSA)	€£:	Certificate No. (CSA)	
			200039-1121690
Rated voltage (Use group B / CSA)	50 V	Rated voltage (Use group C / CSA)	50 V
Rated voltage (Use group D / CSA)	150 V	Rated current (Use group B / CSA)	5 A
Rated current (Use group C / CSA)	9.5 A	Rated current (Use group D / CSA)	9.5 A
Reference to approval values	Specifications are maximum values, details - see approval certificate.		

### Rated data acc. to UL 1059

Institute (cURus)	
	C The US

Certificate No. (cURus)

Rated voltage (Use group B / UL 1059)	150 V
Rated voltage (Use group D / UL 1059)	50 V
Rated current (Use group C / UL 1059)	9.5 A
Reference to approval values	Specifications are

Rated voltage (Use group C / UL 1059)	50 V
Rated current (Use group B / UL 1059)	9.5 A
Rated current (Use group D / UL 1059)	9.5 A

F60693

### **Packing**

Packaging	Box	VPE length	53 mm
VPE width	105 mm	VPE height	160 mm

see approval certificate.

### Classifications

ETIM 6.0	EC002637	ETIM 7.0	EC002637
ECLASS 9.0	27-44-04-02	ECLASS 9.1	27-44-04-02
ECLASS 10.0	27-44-04-02	ECLASS 11.0	27-46-02-01

LCEA00 10.0	27 44 04 02	LCLAGG 11.0	27 40 02 01
Important note			
IPC conformity	standards and norms a		vered according international recognized the data sheet resp. fulfill decorative properties roducts can be evaluated on request.
Notes	Gold-plated contact	surfaces on request	
	Rated current related	to rated cross-section & min. No. of pole	s.
	Spacing between ro	ws: see hole layout	
	• P on drawing = pitch		
		to the component itself. Clearance and ordance with the relevant application stand	creepage distances to other components are to dards.
	Long term storage or	f the product with average temperature o	of 50 °C and average humidity 70%, 36 months



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## **Technical data**

### **Approvals**

Approvals



ROHS	Conform
UL File Number Search	E60693

### **Downloads**

Approval/Certificate/Document of	
Conformity	Declaration of the Manufacturer
Engineering Data	<u>STEP</u>



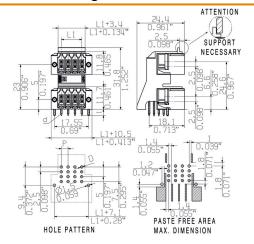
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## **Drawings**

### **Dimensional drawing**



X

0,258" 9

SHOWN: S2CD-THR 3.50/16/90G

24.4 0.961'

0.195

0.039"

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PASTE FREE AREA

MAX. DIMENSION

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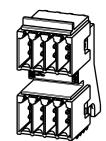
0.059"

0.293

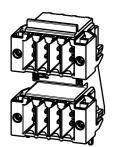
29.8

2.5 0.098'





S2CD-THR 3.50/16/90LF



0.079

X

0.039  $\oplus$   $\oplus$   $\oplus$ **( ( ⊕** 0.047" **① ①**  $\bigcirc$ 0 ⊕ [ **(**+) **( (** 0 PASTE FREE AREA

MAX. DIMENSION

NAME

APORIUS S

HANKE D

74586/5 01.07.14 TIELKER\_S 01

MODIFICATION

DRAWN

RESPONSIBLE

CHECKED

APPROVED

DATE

31.01.2013 FRIELING\_L

07.07.2014 HELIS MA

SHOWN: S2CD-THR 3.50/16/90LF

For the mounting of PCBs, it should be noted that the rated data relates only to the PCB components

The neccessary creepage and clearance paths must be observed in connection with the respective applicant in accordance to IEC 664 / VDE 0110. The current-carrying capacity and pitch tolerance is to be determined according to DIN IEC 326 part 3 very fine.

Weidmüller PCB components are tested to the DIN EN 61984 standard, and are valid for its field of application. Provided that the components are used to the intended purpose, all requirements with respect to the occuring of electrical, mechanical, thermic and corrosive stress will be satisfied.

36	59.5	2.343	
32	52.5	2.067	
28	45.5	1.791	
2 4	38.5	1.516	
20	31.5	1.240	
16	24.5	0.965	
12	17.5	0.689	
8	10.5	0.413	
n POLZAHL POLES	L1 [mm]	L1 [inch]	
CAT NO .			

 $d = \begin{array}{c} 0.8 \times 0.8 \\ 0.031 \\ \end{array} \times 0.031$ 

7400

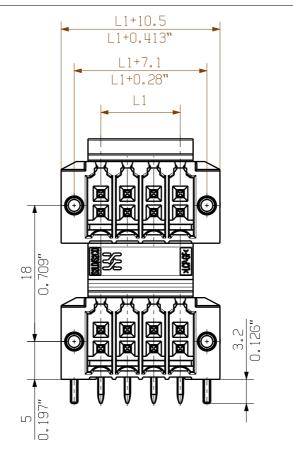
S2CD-THR 3.50/.../90

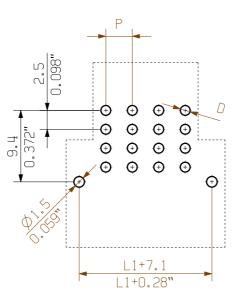
MALE HEADER

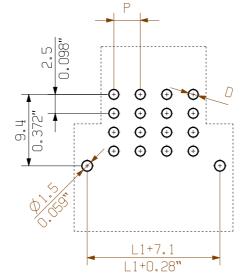
PRODUCT FILE: B2CF/S2C

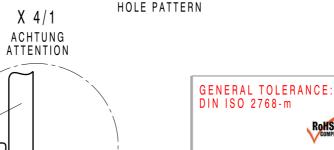
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 $D = { 0.051 \atop 0.051}^{+ 0.1}$ 



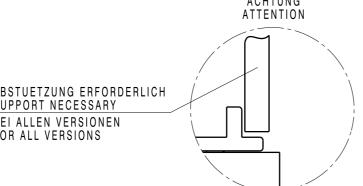


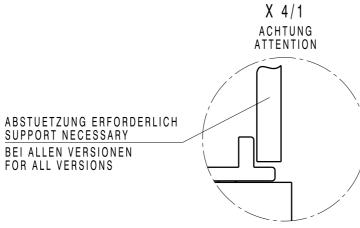


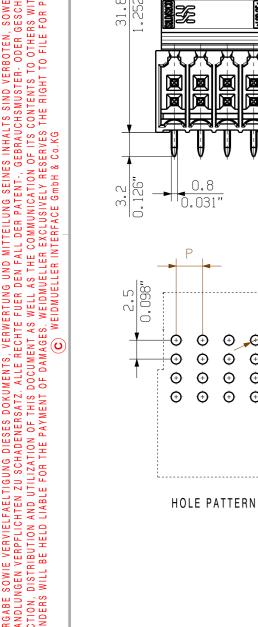


SCALE: 2/1

SUPERSEDES:







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### Recommended wave solderding profiles

#### Weidmüller Interface GmbH & Co. KG

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### Single Wave:



#### **Double Wave:**



### Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.



### Recommended reflow soldering profile

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### Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- · Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- · Maximum heating rate
- Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically  $\leq +3$ K/s. In parallel the solder paste is ,activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at  $\geq$  -6K/s solder is cured. Board and components cool down while avoiding cold cracks.